

DESCRIPTION

The SPN4906 is the Dual N-Channel enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where high-side switching, low in-line power loss, and resistance to transients are needed.

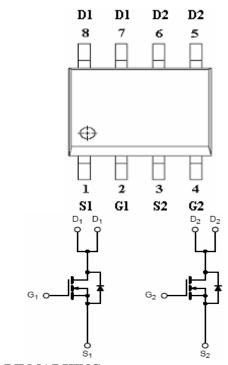
FEATURES

- N-Channel 40V/6.0A, RDS(ON)= $45m\Omega@VGS$ = 10V 40V/5.0A, RDS(ON)= $54m\Omega@VGS$ = 4.5V 40V/4.5A, RDS(ON)= $83m\Omega@VGS$ = 2.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ♦ SOP 8P package design

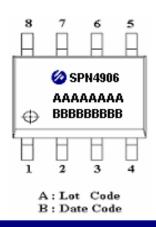
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOP - 8P)



PART MARKING



2009/07/20 **Ver.1**

PIN DESCRIPTION

Pin	Symbol	Description	
1	S1	Source 1	
2	G1	Gate 1	
3	S2	Source 2	
4	G2	Gate 2	
5	D2	Drain 2	
6	D2	Drain 2	
7	D1	Drain 1	
8	D1	Drain 1	

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN4906S8RGB	SOP- 8P	SPN4906

[※] SPN4906S8RGB 13" Tape Reel; Pb − Free; Halogen − Free

ABSOULTE MAXIMUM RATINGS

(Ta=25°C Unless otherwise noted)

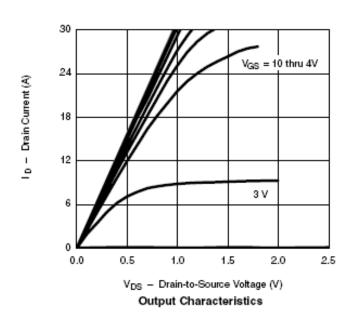
Parameter	Symbol	Typical	Unit		
Drain-Source Voltage		Vdss	40	V	
Gate –Source Voltage		VGSS	±20	V	
Continuos Durin Comput(Tr-150°C)	Ta=25°C	ID	6.0	Α	
Continuous Drain Current(T₁=150°C)	Ta=70°C		5.0		
Pulsed Drain Current	•	IDM	25	Α	
Continuous Source Current(Diode Conduction)		Is	2.3	Α	
D	Ta=25°C	D	2.5	***	
Power Dissipation	Ta=70°C	Pd	1.6	W	
Operating Junction Temperature		Тл	-55/150	$^{\circ}\!\mathbb{C}$	
Storage Temperature Range		Tstg	-55/150	$^{\circ}\!\mathbb{C}$	
Thermal Resistance-Junction to Ambient	$\frac{T \le 10 sec}{\text{Steady State}}$	R _θ JA	50 80	°C/W	

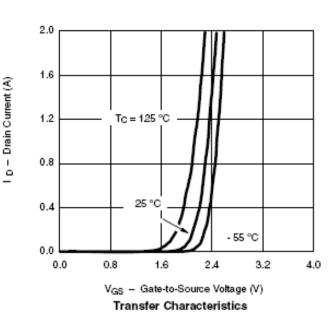
ELECTRICAL CHARACTERISTICS

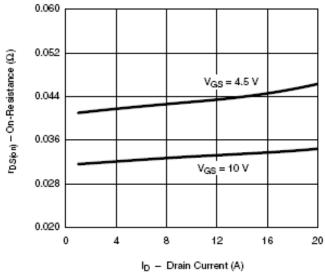
(TA=25°C Unless otherwise noted)

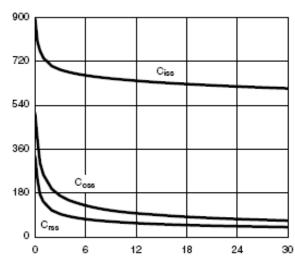
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static	.		· ·	<u>, </u>			
Drain-Source Breakdown Voltage	V(BR)DSS	V _{GS} =0V,I _D =250uA	40			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.5		1.0		
Gate Leakage Current	Igss	V _{DS} =0V,V _{GS} =±12V			±100	nA	
		V _{DS} =40V,V _{GS} =0V			1		
Zero Gate Voltage Drain Current	Idss	V _{DS} =40V,V _{GS} =0V T _J =85°C			5	uA	
On-State Drain Current	ID(on)	V_{DS} = 5V, V_{GS} =4.5V	10			A	
	RDS(on)	V _{GS} = 10V,I _D =6.0A		0.040	0.045	Ω	
Drain-Source On-Resistance		Vgs=4.5V,Id=5.0A		0.047	0.054		
		V _{GS} =2.5V,I _D =4.5A		0.075	0.083		
Forward Transconductance	gfs	VDS=15V,ID=6.2A		13		S	
Diode Forward Voltage	Vsd	Is=2.3A,V _{GS} =0V		0.8	1.2	V	
Dynamic							
Total Gate Charge	Qg			16	24	nC	
Gate-Source Charge	Qgs	V _{DS} =15V,V _{GS} =10V I _D = 2A		3			
Gate-Drain Charge	Qgd	-1D 2/1		2.5]	
Turn-On Time	td(on)			15	20	nS	
Turn-On Time	tr	V _{DD} =15V,R _L =15Ω		6	12		
T. OMT.	td(off)	$I_{D}=1.0A,V_{GEN}=10V$ $R_{G}=6\Omega$		10	20		
Turn-Off Time	tf]		40	80		

TYPICAL CHARACTERISTICS









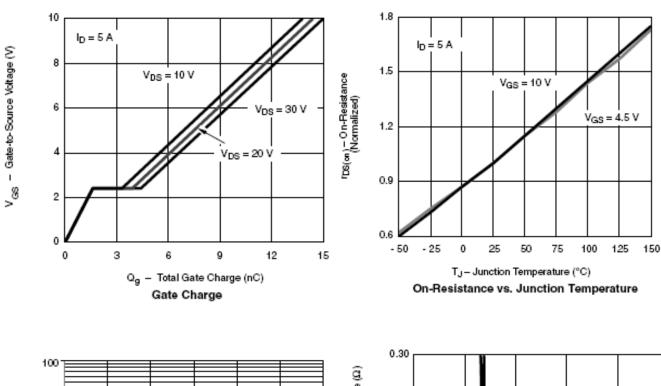
On-Resistance vs. Drain Current and Gate Voltage

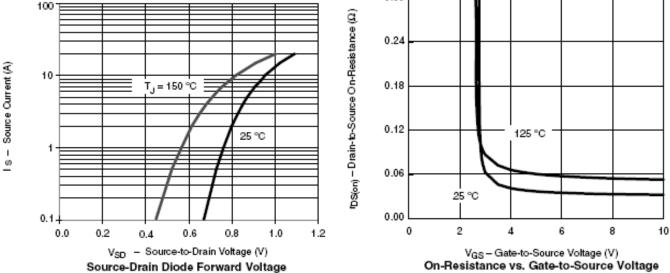
V_{DS} - Drain-to-Source Voltage (V)
Capacitance

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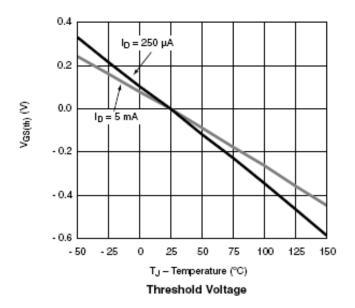
C - Capacitance (pF)

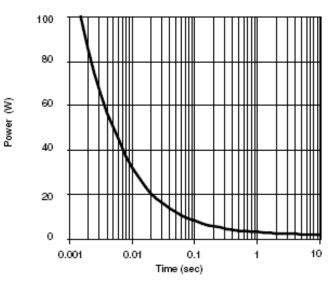
TYPICAL CHARACTERISTICS



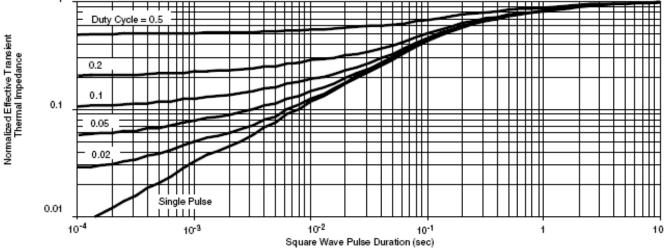


TYPICAL CHARACTERISTICS





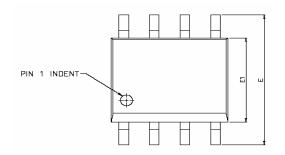
Single Pulse Power, Junction-to-Ambient

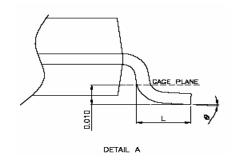


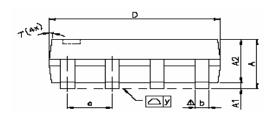
Normalized Thermal Transient Impedance, Junction-to-Foot

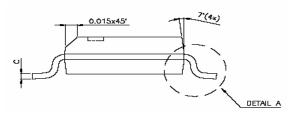


SOP- 8 PACKAGE OUTLINE









DIMENSIONS IN MILLIMETERS			IMETERS	DIMENSIONS IN INCHES		
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10		0.25	0.004		0.010
A2		1.45			0.057	
Ь	0.33	0.41	0.51	0.013	0.016	0.020
С	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
Е	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е	_	1.27	_		0.050	
L	0.38	0.71	1.27	0.015	0.028	0.050
<u>∕</u> 2∖ y			0.076			0.003
0	0°	_	8*	0,		8*

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